

# UNISONIC TECHNOLOGIES CO., LTD

## 2N90Z

### Power MOSFET

## 2A, 900V N-CHANNEL POWER MOSFET

#### DESCRIPTION

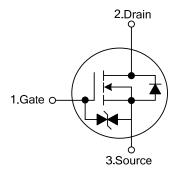
The UTC **2N90Z** is an N-channel mode power MOSFET using UTC's advanced technology to provide costumers with planar stripe and DMOS technology. This technology specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **2N90Z** is universally applied in high efficiency switch mode power supply.



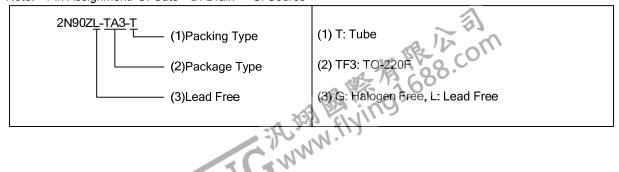
- \* R<sub>DS(ON)</sub> = 7.2Ω @V<sub>GS</sub> = 10 V
- \* Typically 5.5 pF low C<sub>RSS</sub>
- \* High switching speed
- \* Typically 12nC low gate charge
- \* Improved dv/dt capability
- \* 100% avalanche tested

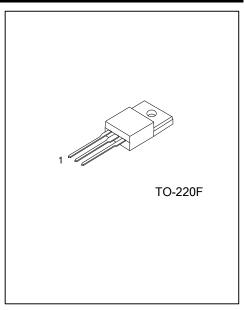
#### SYMBOL



#### ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Packing	
Lead Free	Halogen Free	Package	1	2	3	Facking	
2N90ZL-TF3-T	2N90ZG-TF3-T	TO-220F	G	D	S	Tube	
Note: Pin Assignment: G: C	ate D: Drain S: Source						





#### ■ ABSOLUTE MAXIMUM RATINGS (Tc=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage (Note 2)		V <sub>DSS</sub>	900	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Drain Current	Continuous	ID	2.2	А
Drain Current	Pulsed (Note 2)	I <sub>DM</sub>	8.8	А
Avalanche Current (Note 2)		I <sub>AR</sub>	2.2	А
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	170	mJ
	Repetitive (Note 2)	E <sub>AR</sub>	8.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.0	V/ns
Power Dissipation		PD	25	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55~+150	С°

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

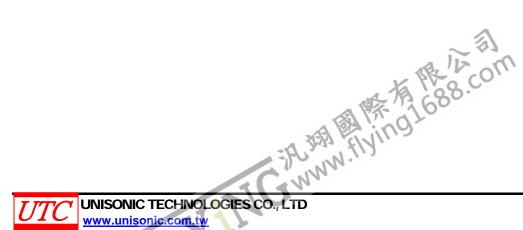
2. Repetitive Rating: Pulse width limited by maximum junction temperature

3. L = 65mH,  $I_{AS}$  = 2.2A,  $V_{DD}$  = 50V,  $R_{G}$  = 25 $\Omega$ , Starting  $T_{J}$  = 25°C

4.  $I_{SD} \le 2.2A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ <sub>JA</sub>	62.5	°C/W	
Junction to Case	$\theta_{Jc}$	5	°C/W	



#### ■ ELECTRICAL CHARACTERISTICS (T<sub>c</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	900			V
Breakdown Voltage Temperature Coefficient		∆BV <sub>DSS</sub> /∆T <sub>J</sub>	Reference to 25°C, I <sub>D</sub> =250µA		1.0		V/°C
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =900V, V <sub>GS</sub> =0V			10	
			V <sub>DS</sub> =720V, T <sub>C</sub> =125°C			100	μA
Gate- Source Leakage Current	Forward		V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			5	μA
	Reverse	I <sub>GSS</sub>	V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-5	μA
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	3.0		5.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.1A		5.6	7.2	Ω
Forward Transconductance		<b>g</b> fs	V <sub>DS</sub> =50V, I <sub>D</sub> =1.1A (Note 1)		2.0		S
DYNAMIC PARAMETERS							
Input Capacitance		C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		390	500	pF
Output Capacitance		C <sub>OSS</sub>			45	60	pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			5.5	7.0	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q <sub>G</sub>			12	15	nC
Gate to Source Charge		Q <sub>GS</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =720V, I <sub>D</sub> =2.2A		2.8		nC
Gate to Drain Charge		Q <sub>GD</sub>	(Note 1,2)		6.1		nC
Turn-ON Delay Time		t <sub>D(ON)</sub>			15	40	ns
Rise Time		t <sub>R</sub>	V <sub>DD</sub> =450V, I <sub>D</sub> =2.2A, R <sub>G</sub> =25Ω		35	80	ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	(Note 1,2)		20	50	ns
Fall-Time		t <sub>F</sub>	1		30	70	ns
SOURCE- DRAIN DIODE RATI	NGS AND CH	ARACTERISTI	CS				
Maximum Continuous Drain-Source Diode Forward Current		I <sub>S</sub>				2.2	^
						2.2	A
Maximum Pulsed Drain-Source Diode		I <sub>SM</sub>				8.8	٨
Forward Current						0.0	A
Drain-Source Diode Forward Voltage		V <sub>SD</sub>	I <sub>S</sub> =2.2A, V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time		t <sub>rr</sub>	I <sub>S</sub> =2.2A,V <sub>GS</sub> =0V,dI <sub>F</sub> /dt=100A/µs (Note 1)		400		ns
Reverse Recovery Charge		Q <sub>RR</sub>			1.6		μC

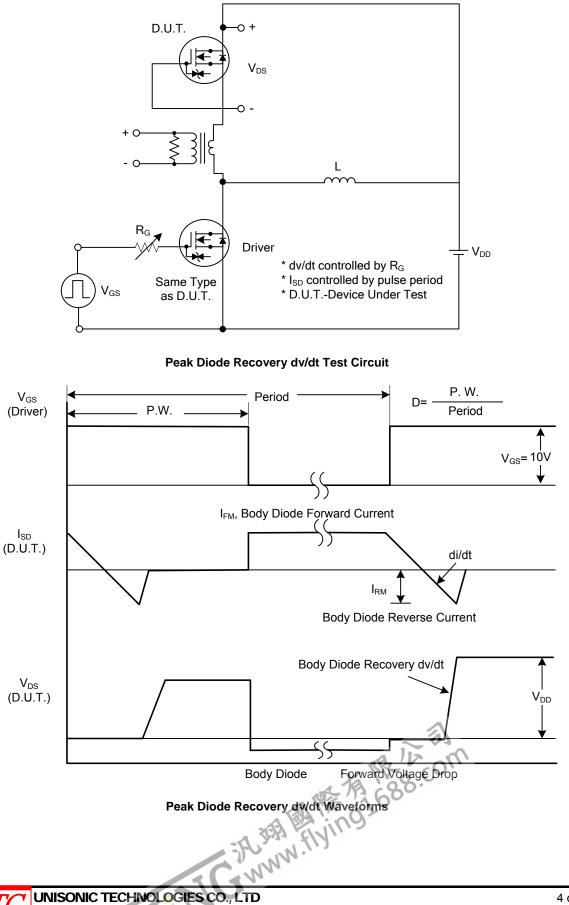
Note: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2%

2. Essentially independent of operating temperature

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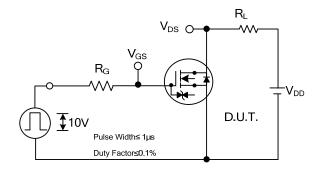
#### TEST CIRCUITS AND WAVEFORMS

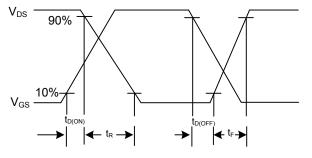
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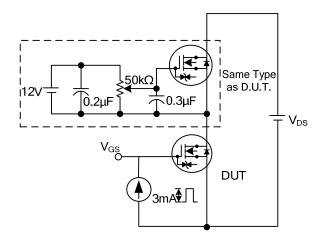
#### **TEST CIRCUITS AND WAVEFORMS (Cont.)**



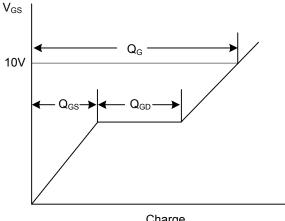


**Switching Test Circuit** 



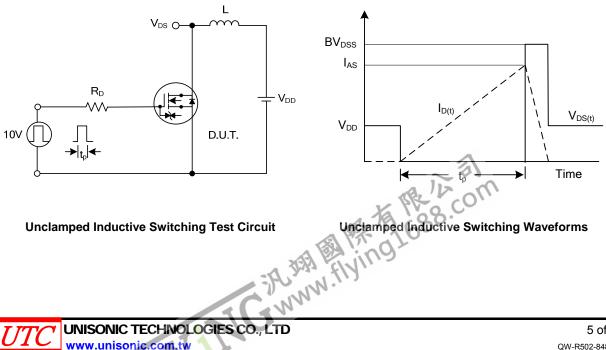


**Gate Charge Test Circuit** 

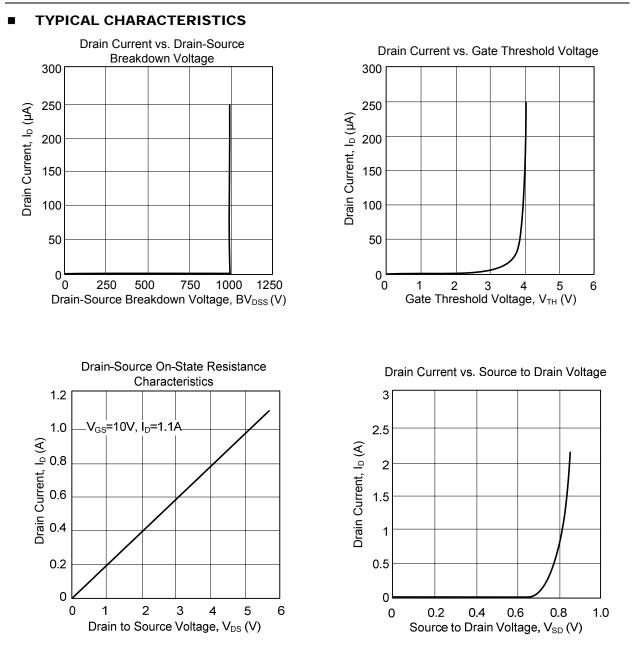


Charge

**Gate Charge Waveform** 



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